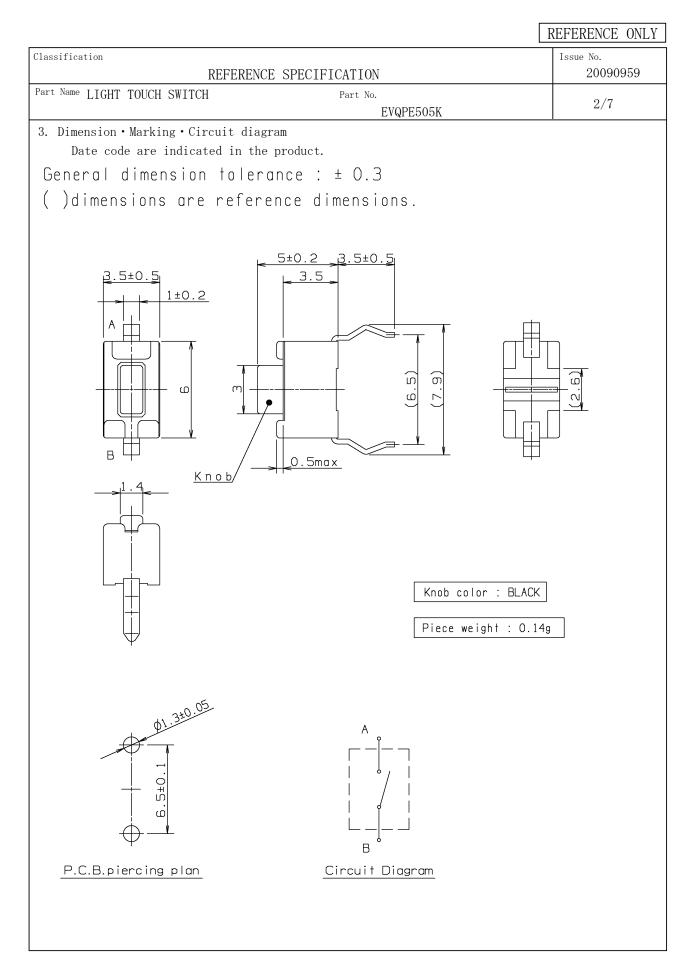
Classification	Issue No.
REFERENCE SPECIFICATION	20090959
Part Name LIGHT TOUCH SWITCH Part No. EVQPE505K	1/7
 Notification Items I Law and the regulation which are applied 	ertain /95/EC). Concerning at is subject
1.2 Application Limits This product was designed and manufactured for general electronics devices appliances, office equipment, data and communication equipment. For the following applications in which high reliability and safety are re- the applications in which the failure or malfunction of the products may d jeopardize life or cause threat of personal asset, please contact us befor ·Aircraft and aerospace equipment, anti-disaster or anti-crime equipment, equipment, transport equipment (automotives, trains, boat etc), high pui information processing devices or the other equipments or devices that equivalent to the above mentioned.	quired, or for irectly rehand. medical blic
 1.3 Handling of reference specification. Since the contents of this reference specification are subjected to change prior notifications, please request us a formal specification again for you investigations before using. 	
1.4 Manufacturing Sites	
 The country of manufacture : Japan Panasonic Electronic Devices Japan Co., Ltd. 	
 Summary This specifications applies to the following types of switch. Push-ON type S.P.S.T 	
2.2 This specifications is a constituent document of contract for business con your company and Panasonic Corporation.	ncluded between
2.3 Items not particularly specified in this specifications shall be in confo JIS Standards.	rmance with



Classification	Issue No. 20090959					
Part Name LIGHT TOUCH SWI			3/7			
4. General specification	EVQPE505K					
4. 1 Switch rating						
4.2 Operation temperat	4.2 Operation temperature range $-30~^{\circ}\mathrm{C} \sim +85~^{\circ}\mathrm{C}$					
4.3 Preservative tempe	erature range Single condition : -40~+85 °C					
4.4 Standard conditions Unless otherwise specified, the test and measurements shall be carried out as follows. Ambient temperature:5~35 ℃ Relative humidity :45~85 % Air pressure :86~106 kPa However, if doubt arises on the decision based on the measured values under the above-mentioned conditions, the following conditions shall be employed. Ambient temperature:20± 2℃ Relative humidity :65±5 % Air pressure :86~106 kPa						
5. Performance						
5.1 Electrical charact	teristics					
No. ITEM	TEST CONDITION]	PERFORMANCE			
5.1.1 Contact resistance	Push force : {Operation force} \times 2 Measurement tool : Contact resistance meter (Capable of 10 μ A \sim 10 mA)	100	mΩ max.			
5.1.2 Insulation resistance	DC 100 V (Between terminals)	100	MΩ min.			
5.1.3 Withstand voltage	AC 250 V for 1 minute. (Between terminals)	No in	nsulation destruction			
5.1.4 Bouncing	Operation speed : 3~4 times/s D. C. 10V 10kΩ 10kΩ Switch Bouncing Test Circuit	OFF	Oms max. Oms max.			

rt Name	LIGHT TOUCH SU			4/7
5 2 Ma	chanical charac	EVQPE505K		_, .
No.	ITEM	TEST CONDITION	PERI	FORMANCE
5. 2. 1	Operation force	Push force Return force Stroke ->	Push forc Return fo	$1.6 \stackrel{+}{-} \stackrel{0.5}{_{-} 0.5}$ N
5. 2. 2	Travel to closure	Push by recommended operating condition. (4.2) F={Operation force} ×2 F Travel	0.25	+ 0. 20 - 0. 10 mm
5.2.3	Push strength	50 N for 60 sec.	No damage (Electric med	
5. 2. 4	Pull strength		20 N min.	
5. 2. 5	Vibration test	 Amplitude : 1.5 mm Sweep rate : 10-55-10Hz for 1 minute Sweep method : Logarithmic frequency sweep rate Vibration direction : X, Y, Z(3 directions) Time : Each direction 2 hours (Total 6 hours) 	No.5.1 and 5.2.1 to be satisf	5.2.2 shall
5.2.6	Soldering heat test	Soldering area : 1/2 of P.W.B. thickness Soldering temperature : 260±5℃ Soldering time : 5±1 sec.	No damage (Electrica mechanica]	
5. 2. 7	Solderbility	After spreading flux, the terminal is immersed in solder with following condition. Solder ber : M705/Sn-3.0Ag-0.5Cu (Senju Metal Indusry Co.,Ltd.) Flux : CF-110VH-2A (tamura kaken) Soldering temperture : 260±5℃ Soldering time : 2±0.5 sec.	area(Excl surface)w immersed	

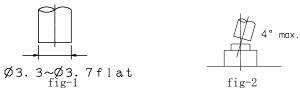
assifica	tion	REFERENCE SPECIFICATION	Issue No. 20090959	
rt Name	LIGHT TOUCH SW	/ITCH Part No.	5/7	
3 C1i	matic characte	EVQPE505K		
			DDDDDDUUNOD	
No.	ITEM	TEST CONDITION	PERFORMANCE	
5. 3. 1	Cold test	 Temperature : -40±2 ℃ Duration of test : 500 h Take off a drop water. Standard conditions after test : 1 h 	Contact resistance 200 m Ω max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5. 3. 2	Heat test	 Temperature : 85±2 ℃ Duration of test : 500 h Standard conditions after test : 1 h 	Contact resistance 200 m Ω max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5. 3. 3	Heat shock test	1) Test cycles : 20 cycles 2) Standard conditions after test : 1 h A B	Contact resistance 200 m Ω max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5.3.4	Humidity test	 Temperature : 60±2 °C Relative humidity : 90~95 % Duration of test : 500 h Take off a drop water. Standard conditions after test : 1 h 	Contact resistance 200 m Ω max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	
5. 3. 5	Endurance (Switching action)	 DC 12 V 50 mA Resistance load Operation speed : 2~3 times/s Push force : Maximum value of operation force Operation number : 50,000 times 	Contact resistance $200m \ \Omega$ max. Bouncing : 10 ms max. Variation rate of operation force shall be within $\pm 30 \ \%$ to the value before testing No. 5. 1. 2 and 5. 2. 2 shall be satisfied.	
5. 3. 6	Withstand H ₂ S	 Density : 3±1 ppm Temperature : 40±2 ℃ Relative humidity : 80~85 % Duration of test : 24 h Standard conditions after test : 1 h 	Contact resistance 200 m Ω max. No. 5. 1. 2 to 5. 1. 4 and No. 5. 2. 1 to 5. 2. 2 shall be satisfied.	

Classification		Issue No.	
REFERENCE SPECIFICATION		20090959	
Part Name LIGHT TOUCH SWITC	CH Part No.	6/7	
	EVQPE505K		
6. Prohibitions and preca	ution for handling		
6.1 Soldering condition	-		
ITEM	CONDITION		
Preheat temperature	110°C max. (Environmental temperature of soldering surface of P.W.B.		
Preheat time	60 sec. max.		
Area of flux	1/2 max. of P.W.B. thickness		
Temperature of solder	260 ± 5 °C		
Time of immersion	Within 5 sec.		
Soldering number	number Within 2 times (But should bring down heat of the first soldering.)		
Printed wiring board	Single sided copper-clad laminates		
	soldered, please be careful not to clean switches wit	th solvent.	

- 3) In the case of using soldering iron, soldering conditions shall be 350 °C max. 3 sec. max. 1 time only and the tip of iron must not touch to terminals. Soldering iron for re-soldering have to be 60W max.
- 4) Right after switches were soldered, please be carefull not to load on the knobs of switches.

6.2 Design instructions

- 1) Please refer to the land pattern plan Panasonic recommends on the 2nd page.
- Design key top as fig-1. Design inclination of key top 4 deg. max. as fig-2. (Recommended operation condition)



6.3 Notes

- 1) Please be cautions not to give excessive static load or shock to switches.
- 2) Please be careful not to pile up P.W.B. after switches were soldered.
- 3) Preservation under high temperature and high humidity or corrosive gas should be avoided especially. When you need to preserve for a long period, do not open the carton.
- 4) Avoid the use of the switch under pushed ON condition is continued for a long time.

Panasonic Electronic Devices Co., Ltd.

Classification REFERENCE SPECIFICATION	Issue No. 20090959
Part Name LIGHT TOUCH SWITCH Part No.	
EVQPE505K	7/7
<pre><prohibitions and="" for="" handling="" precaution=""> [Prohibited items on fire and smoking] • Absolutely avoid use of a product beyond its rated range because doing so may If misuse or abnormal use may result under conditions in which the product is rated range, take proper measures such as current interruption using a protectiv • The grade of nonflammability for resin used in product is "94HB," which is bas Standards (flammability test for plastic materials). Prohibit use in a locatic spreading fire may be generated or prepare against a spreading fire.</prohibitions></pre>	used out of its ve circuit. ed on UL94
 [For use in equipment for which safety is requested] Although care is taken to ensure product quality, inferior characteristics, shor and open circuits are some problems that might be generated. To design an equiplaces maximum emphasis on safety, review the effect of any single fault of a p in advance and perform virtually fail-safe design to ensure maximum safety by: Preparing a protective circuit or a protective device to improve system safet Preparing a redundant circuit to improve system safety so that the single faul of a product does not cause a dangerous situation. 	pment which product y, and equipment.
[Attentions required for storage condition] •When this product is to be stored in the following circumstances and condition affect on the performance deteriorations and solderability etc., avoid storing following conditions. (1) A place where the temperature is -10°C max., +40°C min. and the humidity is 3 (2) In the corrosive gas atmosphere. (3) Long-term storage for 6 months min. (4) A place where the product is exposed to direct sunlight. • Store in packed condition so that the load stress is not applied. • Please use this product as soon as possible, our recommendation is within 3 mon limitation is 6 months. • If any remainder left after packing is opened, store it with proper moistureprogasproofing, etc.,	in the 85% min. ths and the